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Deposition and Characterization of Thin Metallic- and Semiconductor-Based Films

Guest Editor:

Dr. Maja Mičetić

Ruđer Bošković Institute, Bijenička cesta 54, Zagreb 10000, Croatia

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Message from the Guest Editor

The aim of this Issue is to provide insight into the recent development of techniques for the preparation and characterization of thin films. Especially interesting are the techniques enabling the self-assembled growth of regularly ordered nanostructures, complex nano-objects like core/shell nanoparticles or nanowires, as well as all types of thin films with some interesting properties and/or applications. Another focus of this Issue concerns the modern techniques for the efficient characterization of the thin films' properties. Grazing incidence X-ray based techniques are welcomed, as well all others techniques sensitive to the close-to-the-surface area of the material. Techniques for the characterization of the optical and electrical properties of the thin films are of high interest as well.

Keywords

- Deposition of semiconductor- and metallic-based thin films
- thin film characterization









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Editor-in-Chief

Prof. Dr. Maryam Tabrizian

 Department of Biomedical Engineering, Faculty of Medicine and Health Sciences, McGill University, Montreal, QC H3A 2B6, Canada
Faculty of Dentistry and Oral Health Sciences, McGill University, 3640 Rue University, Montreal, QC H3A 0C7, Canada

Message from the Editor-in-Chief

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Materials Editorial Office MDPI, Grosspeteranlage 5 4052 Basel, Switzerland Tel: +41 61 683 77 34 www.mdpi.com mdpi.com/journal/materials materials@mdpi.com X@Materials_Mdpi